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#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

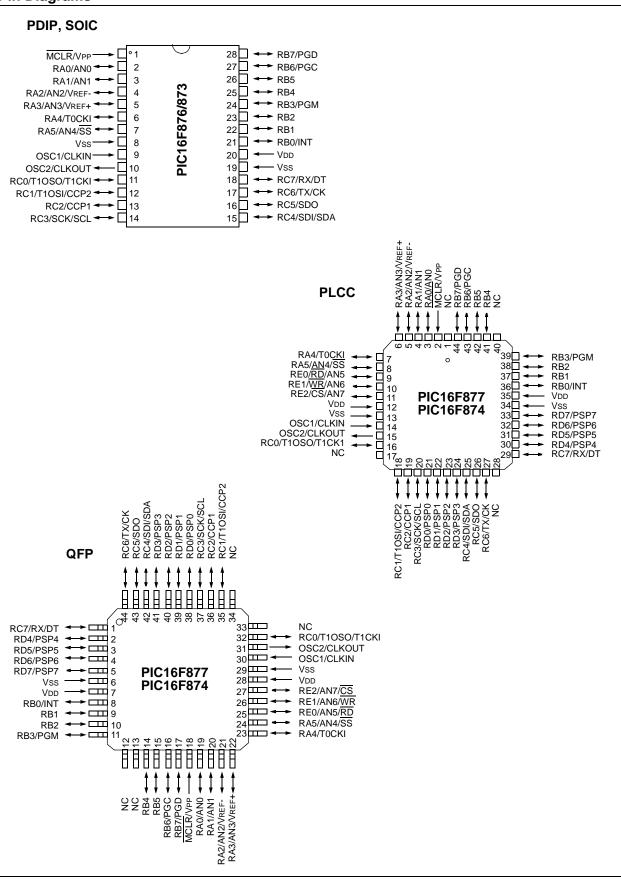
#### Details

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f874t-20-l

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

#### **Pin Diagrams**



Pin Name	DIP Pin#	PLCC Pin#	QFP Pin#	l/O/P Type	Buffer Type	Description
						PORTC is a bi-directional I/O port.
RC0/T1OSO/T1CKI	15	16	32	I/O	ST	RC0 can also be the Timer1 oscillator output or a Timer1 clock input.
RC1/T1OSI/CCP2	16	18	35	I/O	ST	RC1 can also be the Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output.
RC2/CCP1	17	19	36	I/O	ST	RC2 can also be the Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	18	20	37	I/O	ST	RC3 can also be the synchronous serial clock input/ output for both SPI and I <sup>2</sup> C modes.
RC4/SDI/SDA	23	25	42	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I <sup>2</sup> C mode).
RC5/SDO	24	26	43	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK	25	27	44	I/O	ST	RC6 can also be the USART Asynchronous Transmi or Synchronous Clock.
RC7/RX/DT	26	29	1	I/O	ST	RC7 can also be the USART Asynchronous Receive or Synchronous Data.
						PORTD is a bi-directional I/O port or parallel slave port when interfacing to a microprocessor bus.
RD0/PSP0	19	21	38	I/O	ST/TTL <sup>(3)</sup>	
RD1/PSP1	20	22	39	I/O	ST/TTL <sup>(3)</sup>	
RD2/PSP2	21	23	40	I/O	ST/TTL <sup>(3)</sup>	
RD3/PSP3	22	24	41	I/O	ST/TTL <sup>(3)</sup>	
RD4/PSP4	27	30	2	I/O	ST/TTL <sup>(3)</sup>	
RD5/PSP5	28	31	3	I/O	ST/TTL <sup>(3)</sup>	
RD6/PSP6	29	32	4	I/O	ST/TTL <sup>(3)</sup>	
RD7/PSP7	30	33	5	I/O	ST/TTL <sup>(3)</sup>	
						PORTE is a bi-directional I/O port.
RE0/RD/AN5	8	9	25	I/O	ST/TTL <sup>(3)</sup>	RE0 can also be read control for the parallel slave port, or analog input5.
RE1/WR/AN6	9	10	26	I/O	ST/TTL <sup>(3)</sup>	RE1 can also be write control for the parallel slave port, or analog input6.
RE2/CS/AN7	10	11	27	I/O	ST/TTL <sup>(3)</sup>	RE2 can also be select control for the parallel slave port, or analog input7.
Vss	12,31	13,34	6,29	Р	_	Ground reference for logic and I/O pins.
Vdd	11,32	12,35	7,28	Р	_	Positive supply for logic and I/O pins.
NC	-	1,17,28, 40	12,13, 33,34		—	These pins are not internally connected. These pins should be left unconnected.
Legend: I = input	0 = 0 — = N	utput lot used		I/O = inp TTL = T	out/output TL input	P = power ST = Schmitt Trigger input

#### TABLE 1-2: PIC16F874 AND PIC16F877 PINOUT DESCRIPTION (CONTINUED)

**Note 1:** This buffer is a Schmitt Trigger input when configured as an external interrupt.

2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

**3:** This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

4: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.

#### FIGURE 2-4: PIC16F874/873 REGISTER FILE MAP

,	File Address	A	File ddress	/	File Address		File Addres
Indirect addr. <sup>(*)</sup>	00h	Indirect addr.(*)	80h	Indirect addr.(*)	100h	Indirect addr.(*)	180h
TMR0	01h	OPTION_REG	81h	TMR0	101h	OPTION_REG	181h
PCL	02h	PCL	82h	PCL	102h	PCL	182h
STATUS	03h	STATUS	83h	STATUS	103h	STATUS	183h
FSR	04h	FSR	84h	FSR	104h	FSR	184h
PORTA	05h	TRISA	85h		105h		185h
PORTB	06h	TRISB	86h	PORTB	106h	TRISB	186h
PORTC	07h	TRISC	87h		107h		187h
PORTD <sup>(1)</sup>	08h	TRISD <sup>(1)</sup>	88h		108h		188h
PORTE <sup>(1)</sup>	09h	TRISE <sup>(1)</sup>	89h		109h		189h
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH	18Ah
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON	18Bh
PIR1	0Ch	PIE1	8Ch	EEDATA	10Ch	EECON1	18Cł
PIR2	0Dh	PIE2	8Dh	EEADR	10Dh	EECON2	18Dł
TMR1L	0Eh	PCON	8Eh	EEDATH	10Eh	Reserved <sup>(2)</sup>	18Eh
TMR1H	0Fh		8Fh	EEADRH	10Fh	Reserved <sup>(2)</sup>	18Fh
T1CON	10h		90h		110h		190h
TMR2	11h	SSPCON2	91h				
T2CON	12h	PR2	92h				
SSPBUF	13h	SSPADD	93h				
SSPCON	14h	SSPSTAT	94h				
CCPR1L	15h		95h				
CCPR1H	16h		96h				
CCP1CON	17h		97h				
RCSTA	18h	TXSTA	98h				
TXREG	19h	SPBRG	99h				
RCREG	1Ah		9Ah				
CCPR2L	1Bh		9Bh				
CCPR2H	1Ch		9Ch				
CCP2CON	1Dh		9Dh				
ADRESH	1Eh	ADRESL	9Eh				
ADCON0	1Fh	ADCON1	9Fh		1206		1A0h
	20h		A0h		120h		
General Purpose Register		General Purpose Register		accesses 20h-7Fh		accesses A0h - FFh	
96 Bytes		96 Bytes		2011 11 11	16Fh 170h		1EFt 1F0h
	754				1756		4
Bank 0	J 7Fh	Bank 1	FFh	Bank 2	17Fh	Bank 3	1FFł
Bank 0 Bank 1 Bank 2 Bank 3 Int 1 Bank 2 Bank 3 Int 2 Bank 3 Int 3 Bank 4 Bank 2 Bank 3 Bank 3 Bank 4 Bank 3 Bank 3 Bank 4 Bank 3 Bank 4 Bank 3 Bank 5 </td							

#### TABLE 3-5:PORTC FUNCTIONS

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output/Timer1 clock input.
RC1/T1OSI/CCP2	bit1	ST	Input/output port pin or Timer1 oscillator input or Capture2 input/ Compare2 output/PWM2 output.
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/ PWM1 output.
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I <sup>2</sup> C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I <sup>2</sup> C mode).
RC5/SDO	bit5	ST	Input/output port pin or Synchronous Serial Port data output.
RC6/TX/CK	bit6	ST	Input/output port pin or USART Asynchronous Transmit or Synchronous Clock.
RC7/RX/DT	bit7	ST	Input/output port pin or USART Asynchronous Receive or Synchronous Data.

Legend: ST = Schmitt Trigger input

#### TABLE 3-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
07h	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
87h	TRISC	PORTC	PORTC Data Direction Register       1111 1111 1111								

Legend: x = unknown, u = unchanged

#### 4.2 Reading the EEPROM Data Memory

Reading EEPROM data memory only requires that the desired address to access be written to the EEADR register and clear the EEPGD bit. After the RD bit is set, data will be available in the EEDATA register on the very next instruction cycle. EEDATA will hold this value until another read operation is initiated or until it is written by firmware.

The steps to reading the EEPROM data memory are:

- 1. Write the address to EEDATA. Make sure that the address is not larger than the memory size of the PIC16F87X device.
- 2. Clear the EEPGD bit to point to EEPROM data memory.
- 3. Set the RD bit to start the read operation.
- 4. Read the data from the EEDATA register.

	LE 4-1.		
BSF	STATUS,	RP1	;
BCF	STATUS,	RP0	;Bank 2
MOVF	ADDR, W		;Write address
MOVWF	EEADR		;to read from
BSF	STATUS,	RP0	;Bank 3
BCF	EECON1,	EEPGD	;Point to Data memory
BSF	EECON1,	RD	;Start read operation
BCF	STATUS,	RP0	;Bank 2
MOVF	EEDATA,	W	;W = EEDATA

EXAMPLE 4-1: EEPROM DATA READ

#### 4.3 Writing to the EEPROM Data Memory

There are many steps in writing to the EEPROM data memory. Both address and data values must be written to the SFRs. The EEPGD bit must be cleared, and the WREN bit must be set, to enable writes. The WREN bit should be kept clear at all times, except when writing to the EEPROM data. The WR bit can only be set if the WREN bit was set in a previous operation, i.e., they both cannot be set in the same operation. The WREN bit should then be cleared by firmware after the write. Clearing the WREN bit before the write actually completes will not terminate the write in progress.

Writes to EEPROM data memory must also be prefaced with a special sequence of instructions, that prevent inadvertent write operations. This is a sequence of five instructions that must be executed without interruptions. The firmware should verify that a write is not in progress, before starting another cycle. The steps to write to EEPROM data memory are:

- 1. If step 10 is not implemented, check the WR bit to see if a write is in progress.
- 2. Write the address to EEADR. Make sure that the address is not larger than the memory size of the PIC16F87X device.
- 3. Write the 8-bit data value to be programmed in the EEDATA register.
- 4. Clear the EEPGD bit to point to EEPROM data memory.
- 5. Set the WREN bit to enable program operations.
- 6. Disable interrupts (if enabled).
- 7. Execute the special five instruction sequence:
  - Write 55h to EECON2 in two steps (first to W, then to EECON2)
  - Write AAh to EECON2 in two steps (first to W, then to EECON2)
  - Set the WR bit
- 8. Enable interrupts (if using interrupts).
- 9. Clear the WREN bit to disable program operations.
- At the completion of the write cycle, the WR bit is cleared and the EEIF interrupt flag bit is set. (EEIF must be cleared by firmware.) If step 1 is not implemented, then firmware should check for EEIF to be set, or WR to clear, to indicate the end of the program cycle.

EXAMPLE 4-2: EEPROM DATA WRITE
--------------------------------

BSF	STATUS,	RP1	;
BSF	STATUS,	RP0	;Bank 3
BTFSC	EECON1,	WR	;Wait for
GOTO	\$-1		;write to finish
BCF	STATUS,	RP0	;Bank 2
MOVF	ADDR, W		;Address to
MOVWF	EEADR		;write to
MOVF	VALUE, W	v	;Data to
MOVWF	EEDATA		;write
BSF	STATUS,	RP0	;Bank 3
BCF	EECON1,	EEPGD	;Point to Data memory
BSF	EECON1,	WREN	;Enable writes
			;Only disable interrupts
BCF	INTCON,	GIE	; if already enabled,
			;otherwise discard
MOVLW			;Write 55h to
MOVWF	EECON2		;EECON2
MOVLW	0xAA		;Write AAh to
MOVWF	EECON2		;EECON2
BSF	EECON1,	WR	;Start write operation
			;Only enable interrupts
BSF	INTCON,	GIE	; if using interrupts,
			;otherwise discard
BCF	EECON1,	WREN	;Disable writes

#### SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS: 94h) REGISTER 9-1: R/W-0 R/W-0 R-0 R-0 R-0 R-0 R-0 R-0 SMP D/A Р R/W BF CKE S UA bit 7 bit 0 bit 7 SMP: Sample bit SPI Master mode: 1 = Input data sampled at end of data output time 0 = Input data sampled at middle of data output time SPI Slave mode: SMP must be cleared when SPI is used in slave mode In I<sup>2</sup>C Master or Slave mode: 1 = Slew rate control disabled for standard speed mode (100 kHz and 1 MHz) 0 = Slew rate control enabled for high speed mode (400 kHz) bit 6 CKE: SPI Clock Edge Select (Figure 9-2, Figure 9-3 and Figure 9-4) SPI mode: For CKP = 0 1 = Data transmitted on rising edge of SCK 0 = Data transmitted on falling edge of SCK For CKP = 1 1 = Data transmitted on falling edge of SCK 0 = Data transmitted on rising edge of SCK In I<sup>2</sup>C Master or Slave mode: 1 = Input levels conform to SMBus spec 0 = Input levels conform to I<sup>2</sup>C specs **D/A**: Data/Address bit (I<sup>2</sup>C mode only) bit 5 1 = Indicates that the last byte received or transmitted was data 0 = Indicates that the last byte received or transmitted was address bit 4 P: STOP bit (I<sup>2</sup>C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a STOP bit has been detected last (this bit is '0' on RESET) 0 = STOP bit was not detected last bit 3 S: START bit (I<sup>2</sup>C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a START bit has been detected last (this bit is '0' on RESET) 0 = START bit was not detected last bit 2 **R/W**: Read/Write bit Information (I<sup>2</sup>C mode only) This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next START bit, STOP bit or not ACK bit. In I<sup>2</sup>C Slave mode: 1 = Read0 = WriteIn I<sup>2</sup>C Master mode: 1 = Transmit is in progress 0 = Transmit is not in progress Logical OR of this bit with SEN, RSEN, PEN, RCEN, or ACKEN will indicate if the MSSP is in IDLE mode. bit 1 **UA**: Update Address (10-bit I<sup>2</sup>C mode only) 1 = Indicates that the user needs to update the address in the SSPADD register 0 = Address does not need to be updated bit BF: Buffer Full Status bit Receive (SPI and I<sup>2</sup>C modes): 1 = Receive complete, SSPBUF is full 0 = Receive not complete, SSPBUF is empty Transmit (I<sup>2</sup>C mode only): 1 = Data transmit in progress (does not include the ACK and STOP bits), SSPBUF is full 0 = Data transmit complete (does not include the ACK and STOP bits), SSPBUF is empty Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR

'1' = Bit is set

x = Bit is unknown

'0' = Bit is cleared

#### 9.2.1 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs. The MSSP module will override the input state with the output data, when required (slavetransmitter).

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge ( $\overline{ACK}$ ) pulse, and then load the SSPBUF register with the received value currently in the SSPSR register.

There are certain conditions that will cause the MSSP module not to give this ACK pulse. These are if either (or both):

- a) The buffer full bit BF (SSPSTAT<0>) was set before the transfer was received.
- b) The overflow bit SSPOV (SSPCON<6>) was set before the transfer was received.

If the BF bit is set, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF and SSPOV are set. Table 9-2 shows what happens when a data transfer byte is received, given the status of bits BF and SSPOV. The shaded cells show the condition where user software did not properly clear the overflow condition. Flag bit BF is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low time for proper operation. The high and low times of the  $I^2C$  specification, as well as the requirement of the MSSP module, is shown in timing parameter #100 and parameter #101 of the electrical specifications.

#### 9.2.1.1 Addressing

Once the MSSP module has been enabled, it waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register on the falling edge of the 8th SCL pulse.
- b) The buffer full bit, BF, is set on the falling edge of the 8th SCL pulse.
- c) An ACK pulse is generated.
- d) SSP interrupt flag bit, SSPIF (PIR1<3>), is set (interrupt is generated if enabled) on the falling edge of the 9th SCL pulse.

In 10-bit address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte.

For a 10-bit address, the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address. The sequence of events for a 10-bit address is as follows, with steps 7-9 for slave-transmitter:

- 1. Receive first (high) byte of Address (bits SSPIF, BF and UA (SSPSTAT<1>) are set).
- 2. Update the SSPADD register with the second (low) byte of Address (clears bit UA and releases the SCL line).
- 3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 4. Receive second (low) byte of Address (bits SSPIF, BF and UA are set).
- 5. Update the SSPADD register with the first (high) byte of Address. This will clear bit UA and release the SCL line.
- 6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 7. Receive Repeated Start condition.
- 8. Receive first (high) byte of Address (bits SSPIF and BF are set).
- 9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

Note:	Following the Repeated START condition (step 7) in 10-bit mode, the user only needs to match the first 7-bit address. The
	user does not update the SSPADD for the second half of the address.

#### 9.2.1.2 Slave Reception

When the  $R/\overline{W}$  bit of the address byte is clear and an address match occurs, the  $R/\overline{W}$  bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set, or bit SSPOV (SSPCON<6>) is set. This is an error condition due to user firmware.

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the received byte.

Note: The SSPBUF will be loaded if the SSPOV bit is set and the BF flag is cleared. If a read of the SSPBUF was performed, but the user did not clear the state of the SSPOV bit before the next receive occurred, the ACK is not sent and the SSPBUF is updated.

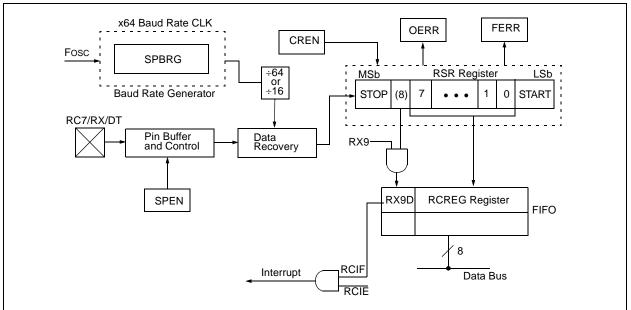
#### 10.2.2 USART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 10-4. The data is received on the RC7/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter, operating at x16 times the baud rate; whereas, the main receive serial shifter operates at the bit rate or at Fosc.

Once Asynchronous mode is selected, reception is enabled by setting bit CREN (RCSTA<4>).

The heart of the receiver is the receive (serial) shift register (RSR). After sampling the STOP bit, the received data in the RSR is transferred to the RCREG register (if it is empty). If the transfer is complete, flag bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/ disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit, which is cleared by the hardware. It is cleared when the RCREG register has been read and is empty. The RCREG is a double buffered register (i.e., it is a two deep FIFO). It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting to the RSR register. On the detection of the STOP bit of the third byte, if the RCREG register is still full, the overrun error bit OERR (RCSTA<1>) will be set. The word in the RSR will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun bit OERR has to be cleared in software. This is done by resetting the receive logic (CREN is cleared and then set). If bit OERR is set, transfers from the RSR register to the RCREG register are inhibited, and no further data will be received. It is therefore, essential to clear error bit OERR if it is set. Framing error bit FERR (RCSTA<2>) is set if a STOP bit is detected as clear. Bit FERR and the 9th receive bit are buffered the same way as the receive data. Reading the RCREG will load bits RX9D and FERR with new values, therefore, it is essential for the user to read the RCSTA register before reading the RCREG register in order not to lose the old FERR and RX9D information.



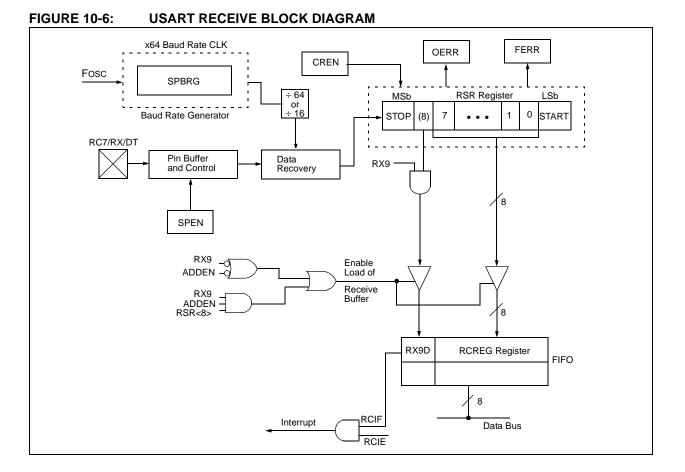


### 10.2.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

When setting up an Asynchronous Reception with Address Detect Enabled:

- Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH.
- Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- If interrupts are desired, then set enable bit RCIE.
- Set bit RX9 to enable 9-bit reception.
- Set ADDEN to enable address detect.
- Enable the reception by setting enable bit CREN.

- Flag bit RCIF will be set when reception is complete, and an interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register, to determine if the device is being addressed.
- If any error occurred, clear the error by clearing enable bit CREN.
- If the device has been addressed, clear the ADDEN bit to allow data bytes and address bytes to be read into the receive buffer, and interrupt the CPU.



#### 12.13 Power-down Mode (SLEEP)

Power-down mode is entered by executing a  $\ensuremath{\mathtt{SLEEP}}$  instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit (STATUS<3>) is cleared, the TO (STATUS<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD or VSS, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D and disable external clocks. Pull all I/O pins that are hi-impedance inputs, high or low externally, to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should also be considered.

The MCLR pin must be at a logic high level (VIHMC).

#### 12.13.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External RESET input on MCLR pin.
- 2. Watchdog Timer Wake-up (if WDT was enabled).
- 3. Interrupt from INT pin, RB port change or peripheral interrupt.

External MCLR Reset will cause a device RESET. All other events are considered a continuation of program execution and cause a "wake-up". The TO and PD bits in the STATUS register can be used to determine the cause of device RESET. The PD bit, which is set on power-up, is cleared when SLEEP is invoked. The TO bit is cleared if a WDT time-out occurred and caused wake-up.

The following peripheral interrupts can wake the device from SLEEP:

- 1. PSP read or write (PIC16F874/877 only).
- 2. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 3. CCP Capture mode interrupt.
- 4. Special event trigger (Timer1 in Asynchronous mode using an external clock).
- 5. SSP (START/STOP) bit detect interrupt.
- SSP transmit or receive in Slave mode (SPI/I<sup>2</sup>C).
- 7. USART RX or TX (Synchronous Slave mode).
- 8. A/D conversion (when A/D clock source is RC).
- 9. EEPROM write operation completion

Other peripherals cannot generate interrupts since during SLEEP, no on-chip clocks are present. When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

#### 12.13.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake-up from SLEEP. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the PD bit. If the PD bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

# PIC16F87X

MOVF	Move f
Syntax:	[ label ] MOVF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(f) $\rightarrow$ (destination)
Status Affected:	Z
Description:	The contents of register f are moved to a destination dependant upon the status of d. If $d = 0$ , destination is W register. If $d = 1$ , the destination is file register f itself. d = 1 is useful to test a file register, since status flag Z is affected.

NOP	No Operation
Syntax:	[label] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Description:	No operation.

MOVLW	Move Literal to W					
Syntax:	[ <i>label</i> ] MOVLW k					
Operands:	$0 \leq k \leq 255$					
Operation:	$k \rightarrow (W)$					
Status Affected:	None					
Description:	The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.					

RETFIE	Return from Interrupt					
Syntax:	[label] RETFIE					
Operands:	None					
Operation:	$TOS \rightarrow PC$ , 1 $\rightarrow GIE$					
Status Affected:	None					

MOVWF	Move W to f						
Syntax:	[ <i>label</i> ] MOVWF f						
Operands:	$0 \leq f \leq 127$						
Operation:	$(W) \rightarrow (f)$						
Status Affected:	None						
Description:	Move data from W register to register 'f'.						

RETLW	Return with Literal in W						
Syntax:	[ <i>label</i> ] RETLW k						
Operands:	$0 \leq k \leq 255$						
Operation:	$k \rightarrow (W);$ TOS $\rightarrow$ PC						
Status Affected:	None						
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.						

#### 15.2 DC Characteristics: PIC16F873/874/876/877-04 (Commercial, Industrial) PIC16F873/874/876/877-20 (Commercial, Industrial) PIC16LF873/874/876/877-04 (Commercial, Industrial) (Continued)

DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions	
	Vol	Output Low Voltage						
D080		I/O ports			0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C	
D083		OSC2/CLKOUT (RC osc config)	—	—	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C	
	Voh	Output High Voltage						
D090		I/O ports <sup>(3)</sup>	Vdd - 0.7		—	V	IOH = -3.0 mA, VDD = 4.5V, -40°С to +85°С	
D092		OSC2/CLKOUT (RC osc config)	Vdd - 0.7	_	—	V	ІОН = -1.3 mA, VDD = 4.5V, -40°С to +85°С	
D150*	Vod	Open-Drain High Voltage		_	8.5	V	RA4 pin	
		Capacitive Loading Specs on Output Pins						
D100	Cosc2	OSC2 pin	_		15	pF	In XT, HS and LP modes when external clock is used to drive OSC1	
D101	Cio	All I/O pins and OSC2 (RC mode)	_	—	50	pF		
D102	Св	SCL, SDA (I <sup>2</sup> C mode)		_	400	pF		
		Data EEPROM Memory						
D120	ED	Endurance	100K	—	_		25°C at 5V	
D121	Vdrw	VDD for read/write	Vmin	—	5.5	V	Using EECON to read/write VMIN = min. operating voltage	
D122	TDEW	Erase/write cycle time	—	4	8	ms		
		Program FLASH Memory						
D130	Eр	Endurance	1000	—	—		25°C at 5V	
D131	Vpr	VDD for read	Vmin	—	5.5	V	VMIN = min operating voltage	
D132A		VDD for erase/write	Vmin	—	5.5	V	Using EECON to read/write, VMIN = min. operating voltage	
D133		Erase/Write cycle time		4	8	ms		

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F87X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

15.3

#### DC Characteristics: PIC16F873/874/876/877-04 (Extended) PIC16F873/874/876/877-10 (Extended) (Continued)

PIC16F873/874/876/877-04 PIC16F873/874/876/877-20 (Extended)			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +125^{\circ}C$						
Param No.	Symbol	Characteristic/ Device	Min	Тур†	Max	Units	Conditions		
	IDD	Supply Current <sup>(2,5)</sup>							
D010			—	1.6	4	mA	RC osc configurations Fosc = 4 MHz, VDD = 5.5V		
D013			-	7	15	mA	HS osc configuration, Fosc = 10 MHz, VDD = 5.5V		
D015	ΔIBOR	Brown-out Reset Current <sup>(6)</sup>	—	85	200	μΑ	BOR enabled, VDD = 5.0V		
	IPD	Power-down Current <sup>(3,5)</sup>							
D020A				10.5	60	μΑ	VDD = 4.0V, WDT enabled		
D021B				1.5	30	μA	VDD = 4.0V, WDT disabled		
D023	ΔIBOR	Brown-out Reset Current <sup>(6)</sup>	—	85	200	μΑ	BOR enabled, VDD = 5.0V		

† Data is "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

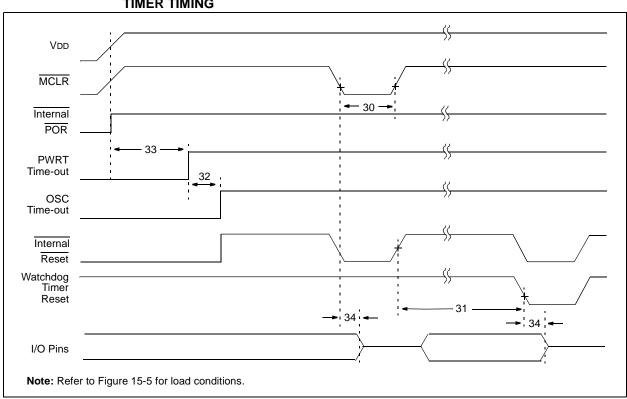
2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading, switching rate, oscillator type, internal code execution pattern and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD;

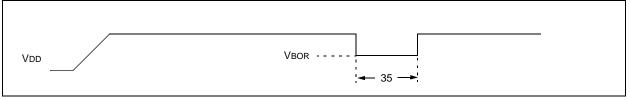
MCLR = VDD; WDT enabled/disabled as specified.

- **3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.
- **5:** Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The  $\Delta$  current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 7: When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.



## FIGURE 15-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

#### FIGURE 15-9: BROWN-OUT RESET TIMING



### TABLE 15-3:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,<br/>AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	-		μs	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc	_	—	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +85°C
34	Tıoz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.1	μS	
35	TBOR	Brown-out Reset pulse width	100	_		μS	$VDD \le VBOR (D005)$

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

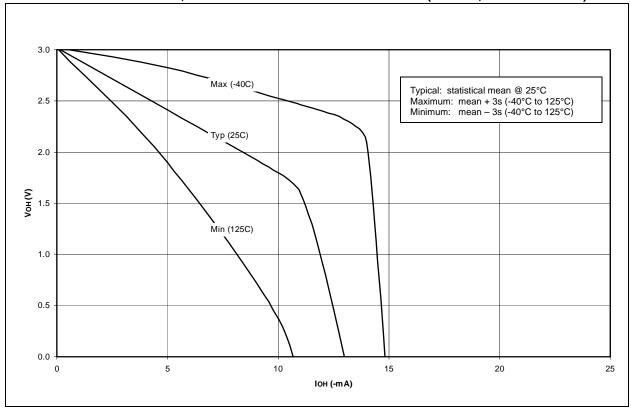
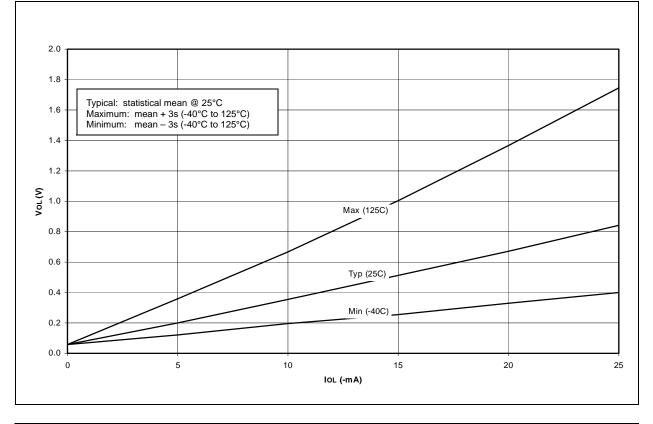


FIGURE 16-17: TYPICAL, MINIMUM AND MAXIMUM VOH vs. IOH (VDD=3V, -40°C TO 125°C)



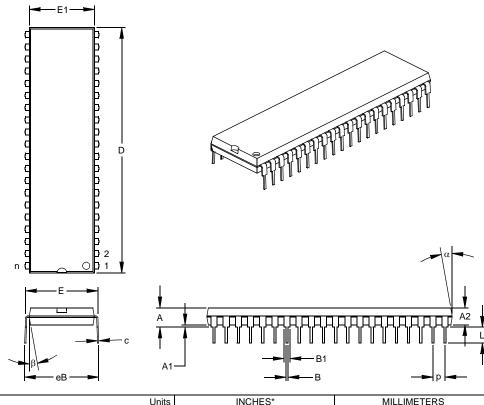


## PIC16F87X

NOTES:

#### 40-Lead Plastic Dual In-line (P) - 600 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES*		MILLIMETERS		
Dimensi	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		40			40	
Pitch	р		.100			2.54	
Top to Seating Plane	А	.160	.175	.190	4.06	4.45	4.83
Molded Package Thickness	A2	.140	.150	.160	3.56	3.81	4.06
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.595	.600	.625	15.11	15.24	15.88
Molded Package Width	E1	.530	.545	.560	13.46	13.84	14.22
Overall Length	D	2.045	2.058	2.065	51.94	52.26	52.45
Tip to Seating Plane	L	.120	.130	.135	3.05	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.030	.050	.070	0.76	1.27	1.78
Lower Lead Width	В	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing §	eB	.620	.650	.680	15.75	16.51	17.27
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15
* 0 / 11' D /							

\* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MO-011

Drawing No. C04-016

## PIC16F87X

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